

Docket No. JCLA3342

12-14-1998

Form 1595
1-31-92

RECORD



100919810

U.S. Department of Commerce
Patent and Trademark Office

JC540 U.S. PTO

09/205866



12/04/98

To the Honorable Assistant Commissioner for Patents: Please record the attached
original documents or copy thereof.

1. Name of conveying party(ies):

Weng-Yi Chen
Kuen-Chu Chen2. Name/address of receiving
Party(ies):

United Integrated Circuits Corp.

3. Nature of conveyance: ☒ Assignment☐ Merger ☐ Security Agreement ☐ Other
☐ Change of Name ☐ ReassignmentNo 3, Li-Hsin Rd. 2, Science-Based
Industrial Park, Hsinchu,
Taiwan, R.O.C.

4. Date(s) of execution: October 29, 1998;

Add'l names of receiving parties

Attached? ☐ Yes ☒ No

5. Application number(s) or patent number(s):

09 205866

**If this documents is being filed together with a new application, the
execution date of the application is October 29, 1998**

A. Patent Application No. (s)

B. Patent No. (s)

Additional numbers attached ? ☐ Yes ☒ No6. Name and address of party to whom
correspondence concerning document
should be mailed:J.C. Patents, Inc.
1340 Reynolds Ave., Suite 114
Irvine, CA 92614
(949) 660-07617. Total No. of applications and patents
involved:

ONE(1)

8. Total fee (37 CFR §3.41): \$40.00

☒ Enclosed☐ Charge to Acct. No.9. Total number of pages, including
cover sheet, attachments and document 3.

DO NOT USE THIS SPACE

10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true
and correct and any attached copy is a true copy of the original document.Jiawei Huang
Name of Person Signing
Signature12/4/98
Date

40.00 DP

Registration No. 43, 330

12/11/1996 JMWKINS 00000096 09205866

185:31 10:581

PATENT

REEL: 9627 FRAME: 0548

ASSIGNMENT

WHEREAS, (1) Weng-Yi Chen

(2) Kuen-Chu Chen

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR PREPARING A DUMMY WAFER

[] Filed: Serial No.

[x] Executed: concurrently with the execution of this instrument

WHEREAS, United Integrated Circuits Corp., of No. 3, Li-Hsin Rd. 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Weng-Yi Chen 29 October 1998

Sole or First Joint Inventor: Weng-Yi Chen

Signature: Kuen-chu Chen October 29, 1998

Second Joint Inventor (if any): Kuen-Chu Chen